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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
	Activo
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	21
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
/oltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx150f128bt-i-ss

TABLE 8: PIN NAMES FOR 36-PIN USB DEVICES

36-PIN VTLA (TOP VIEW)(1,2,3,5)

PIC32MX210F016C PIC32MX220F032C PIC32MX230F064C PIC32MX250F128C

36

1

Pin #	Full Pin Name
1	AN4/C1INB/C2IND/RPB2/SDA2/CTED13/PMD2/RB2
2	AN5/C1INA/C2INC/RTCC/RPB3/SCL2/PMWR/RB3
3	PGED4 ⁽⁴⁾ /AN6/RPC0/RC0
4	PGEC4 ⁽⁴⁾ /AN7/RPC1/RC1
5	VDD
6	Vss
7	OSC1/CLKI/RPA2/RA2
8	OSC2/CLKO/RPA3/PMA0/RA3
9	SOSCI/RPB4/RB4
10	SOSCO/RPA4/T1CK/CTED9/PMA1/RA4
11	AN12/RPC3/RC3
12	Vss
13	VDD
14	VDD
15	TMS/RPB5/USBID/RB5
16	VBUS
17	TDI/RPB7/CTED3/PMD5/INT0/RB7
18	TCK/RPB8/SCL1/CTED10/PMD4/RB8

Pin#	Full Pin Name
19	TDO/RPB9/SDA1/CTED4/PMD3/RB9
20	RPC9/CTED7/RC9
21	Vss
22	VCAP
23	VDD
24	PGED2/RPB10/D+/CTED11/RB10
25	PGEC2/RPB11/D-/RB11
26	Vusb3v3
27	AN11/RPB13/CTPLS/PMRD/RB13
28	CVREFOUT/AN10/C3INB/RPB14/VBUSON/SCK1/CTED5/RB14
29	AN9/C3INA/RPB15/SCK2/CTED6/PMCS1/RB15
30	AVss
31	AVDD
32	MCLR
33	PGED3/VREF+/CVREF+/AN0/C3INC/RPA0/CTED1/PMD7/RA0
34	PGEC3/VREF-/CVREF-/AN1/RPA1/CTED2/PMD6/RA1
35	PGED1/AN2/C1IND/C2INB/C3IND/RPB0/PMD0/RB0
36	PGEC1/AN3/C1INC/C2INA/RPB1/CTED12/PMD1/RB1

Note

- 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and **Section 11.3** "**Peripheral Pin Select**" for restrictions.
- 2: Every I/O port pin (RAx-RCx) can be used as a change notification pin (CNAx-CNCx). See Section 11.0 "I/O Ports" for more information.
- 3: The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to Vss externally.
- 4: This pin function is not available on PIC32MX210F016C and PIC32MX120F032C devices.
- 5: Shaded pins are 5V tolerant.

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2.0 GUIDELINES FOR GETTING STARTED WITH 32-BIT MCUs

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to the documents listed in the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

2.1 Basic Connection Requirements

Getting started with the PIC32MX1XX/2XX 28/36/44-pin Family of 32-bit Microcontrollers (MCUs) requires attention to a minimal set of device pin connections before proceeding with development. The following is a list of pin names, which must always be connected:

- All VDD and Vss pins (see 2.2 "Decoupling Capacitors")
- All AVDD and AVSS pins, even if the ADC module is not used (see 2.2 "Decoupling Capacitors")
- VCAP pin (see 2.3 "Capacitor on Internal Voltage Regulator (VCAP)")
- MCLR pin (see 2.4 "Master Clear (MCLR) Pin")
- PGECx/PGEDx pins, used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes (see 2.5 "ICSP Pins")
- OSC1 and OSC2 pins, when external oscillator source is used (see 2.7 "External Oscillator Pins")

The following pins may be required:

 VREF+/VREF- pins – used when external voltage reference for the ADC module is implemented

Note:

The AVDD and AVss pins must be connected, regardless of ADC use and the ADC voltage reference source.

2.2 Decoupling Capacitors

The use of decoupling capacitors on power supply pins, such as VDD, VSS, AVDD and AVSS is required. See Figure 2-1.

Consider the following criteria when using decoupling capacitors:

- Value and type of capacitor: A value of 0.1 µF (100 nF), 10-20V is recommended. The capacitor should be a low Equivalent Series Resistance (low-ESR) capacitor and have resonance frequency in the range of 20 MHz and higher. It is further recommended that ceramic capacitors be used.
- Placement on the printed circuit board: The
 decoupling capacitors should be placed as close
 to the pins as possible. It is recommended that
 the capacitors be placed on the same side of the
 board as the device. If space is constricted, the
 capacitor can be placed on another layer on the
 PCB using a via; however, ensure that the trace
 length from the pin to the capacitor is within onequarter inch (6 mm) in length.
- Handling high frequency noise: If the board is experiencing high frequency noise, upward of tens of MHz, add a second ceramic-type capacitor in parallel to the above described decoupling capacitor. The value of the second capacitor can be in the range of 0.01 µF to 0.001 µF. Place this second capacitor next to the primary decoupling capacitor. In high-speed circuit designs, consider implementing a decade pair of capacitances as close to the power and ground pins as possible. For example, 0.1 µF in parallel with 0.001 µF.
- Maximizing performance: On the board layout from the power supply circuit, run the power and return traces to the decoupling capacitors first, and then to the device pins. This ensures that the decoupling capacitors are first in the power chain. Equally important is to keep the trace length between the capacitor and the power pins to a minimum thereby reducing PCB track inductance.

4.0 MEMORY ORGANIZATION

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. For detailed information, refer to **Section 3.** "**Memory Organization**" (DS60001115), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family microcontrollers provide 4 GB unified virtual memory address space. All memory regions, including program, data memory, Special Function Registers (SFRs), and Configuration registers, reside in this address space at their respective unique addresses. The program and data memories can be optionally partitioned into user and kernel memories. In addition, the data memory can be made executable, allowing PIC32MX1XX/2XX 28/36/44-pin Family devices to execute from data memory.

Key features include:

- · 32-bit native data width
- Separate User (KUSEG) and Kernel (KSEG0/KSEG1) mode address space
- · Flexible program Flash memory partitioning
- Flexible data RAM partitioning for data and program space
- · Separate boot Flash memory for protected code
- Robust bus exception handling to intercept runaway code
- Simple memory mapping with Fixed Mapping Translation (FMT) unit
- Cacheable (KSEG0) and non-cacheable (KSEG1) address regions

4.1 PIC32MX1XX/2XX 28/36/44-pin Family Memory Layout

PIC32MX1XX/2XX 28/36/44-pin Family microcontrollers implement two address schemes: virtual and physical. All hardware resources, such as program memory, data memory and peripherals, are located at their respective physical addresses. Virtual addresses are exclusively used by the CPU to fetch and execute instructions as well as access peripherals. Physical addresses are used by bus master peripherals, such as DMA and the Flash controller, that access memory independently of the CPU.

The memory maps for the PIC32MX1XX/2XX 28/36/44-pin Family devices are illustrated in Figure 4-1 through Figure 4-6.

Table 4-1 provides SFR memory map details.

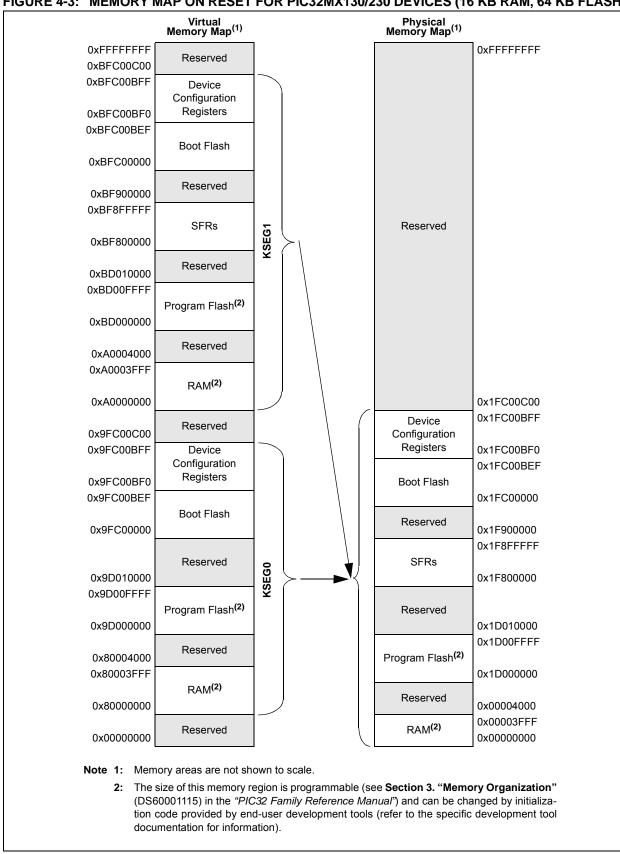


FIGURE 4-3: MEMORY MAP ON RESET FOR PIC32MX130/230 DEVICES (16 KB RAM, 64 KB FLASH)

5.1 Flash Controller Control Registers

TABLE 5-1: FLASH CONTROLLER REGISTER MAP

ess		3								Bit	s								
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
F400	NVMCON ⁽¹⁾	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
F400	INVIVICOIN	15:0	WR	WREN	WRERR	LVDERR	LVDSTAT	_	_	_	_	_	_	_		NVMO	P<3:0>		0000
F410	NVMKEY	31:16								NVMKEY	′~31·0>								0000
1 4 10	IN VIVINE I	15:0								IN V IVINL I	~31.0>								0000
F420	NVMADDR ⁽¹⁾	31:16								NVMADD	2<31.0>								0000
1 720	INVIVIADDIC: .	15:0								INVIVIADO	(1.0								0000
F430	NVMDATA	31:16		NVMDATA<31:0>									0000						
1 +30	NVIVIDAIA	15:0		000									0000						
E440	NVMSRCADDR	31:16							N	VMSDCAL	DR<31:0>								0000
1 +40	INVINIONCADDIN	15:0							i N	VIVIOINOAL	אטוי.טר								0000

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus offsets of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

PIC32MX1XX/2XX 28/36/44-PIN FAMILY

7.0 INTERRUPT CONTROLLER

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 8. "Interrupt Controller"** (DS60001108), which is available from the *Documentation* > *Reference Manual* section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family devices generate interrupt requests in response to interrupt events from peripheral modules. The interrupt control module exists externally to the CPU logic and prioritizes the interrupt events before presenting them to the CPU.

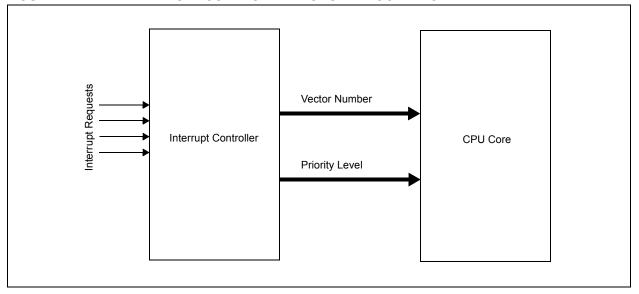
The PIC32MX1XX/2XX 28/36/44-pin Family interrupt module includes the following features:

- · Up to 64 interrupt sources
- · Up to 44 interrupt vectors
- · Single and multi-vector mode operations
- · Five external interrupts with edge polarity control
- · Interrupt proximity timer
- Seven user-selectable priority levels for each vector
- Four user-selectable subpriority levels within each priority
- · Software can generate any interrupt
- User-configurable Interrupt Vector Table (IVT) location
- · User-configurable interrupt vector spacing

Note: The dedicated shadow register set is not present on PIC32MX1XX/2XX 28/36/44-pin Family devices.

A simplified block diagram of the Interrupt Controller module is illustrated in Figure 7-1.

FIGURE 7-1: INTERRUPT CONTROLLER MODULE BLOCK DIAGRAM



REGISTER 7-1: INTCON: INTERRUPT CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	_	_	_	_	_	_
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10	_	_	_	_	_		_	_
45.0	U-0	U-0	U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0
15:8	_	_	_	MVEC	_		TPC<2:0>	
7:0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	_	_	INT4EP	INT3EP	INT2EP	INT1EP	INT0EP

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0' bit 15-13 **Unimplemented:** Read as '0'

bit 12 MVEC: Multi Vector Configuration bit

1 = Interrupt controller configured for Multi-vectored mode
 0 = Interrupt controller configured for Single-vectored mode

bit 11 Unimplemented: Read as '0'

bit 10-8 TPC<2:0>: Interrupt Proximity Timer Control bits

111 = Interrupts of group priority 7 or lower start the Interrupt Proximity timer 110 = Interrupts of group priority 6 or lower start the Interrupt Proximity timer

101 = Interrupts of group priority 5 or lower start the Interrupt Proximity timer

100 = Interrupts of group priority 4 or lower start the Interrupt Proximity timer

011 = Interrupts of group priority 3 or lower start the Interrupt Proximity timer 010 = Interrupts of group priority 2 or lower start the Interrupt Proximity timer

001 = Interrupts of group priority 1 start the Interrupt Proximity timer

000 = Disables Interrupt Proximity timer

bit 7-5 **Unimplemented:** Read as '0'

bit 4 **INT4EP:** External Interrupt 4 Edge Polarity Control bit

1 = Rising edge

0 = Falling edge

bit 3 INT3EP: External Interrupt 3 Edge Polarity Control bit

1 = Rising edge 0 = Falling edge

bit 2

INT2EP: External Interrupt 2 Edge Polarity Control bit

1 = Rising edge0 = Falling edge

bit 1 INT1EP: External Interrupt 1 Edge Polarity Control bit

1 = Rising edge 0 = Falling edge

bit 0 INTOEP: External Interrupt 0 Edge Polarity Control bit

1 = Rising edge 0 = Falling edge

REGISTER 8-4: REFOTRIM: REFERENCE OSCILLATOR TRIM REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0						
24.04	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0						
31:24	ROTRIM<8:1>													
22.40	R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0						
23:16	ROTRIM<0>	_	_	_	_	_	_	_						
45.0	U-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0						
15:8	_	_	_	_	_	_	_	_						
7.0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0						
7:0	_	_	_	_	_	_	_	_						

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-23 ROTRIM<8:0>: Reference Oscillator Trim bits

111111111 = 511/512 divisor added to RODIV value

111111110 = 510/512 divisor added to RODIV value

•

•

100000000 = 256/512 divisor added to RODIV value

•

•

000000010 = 2/512 divisor added to RODIV value

000000001 = 1/512 divisor added to RODIV value

000000000 = 0/512 divisor added to RODIV value

bit 22-0 Unimplemented: Read as '0'

Note: While the ON (REFOCON<15>) bit is '1', writes to this register do not take effect until the DIVSWEN bit is also set to '1'.

REGISTER 10-20: U1CNFG1: USB CONFIGURATION 1 REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	-	1	_	-	-	_	
22:46	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	-	_	_	_	_	_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15.6	_	_	_	_	_	_	_	_
7.0	R/W-0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0
7:0	UTEYE	UOEMON	_	USBSIDL	_	_	_	UASUSPND

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-8 Unimplemented: Read as '0'

bit 7 UTEYE: USB Eye-Pattern Test Enable bit

1 = Eye-Pattern Test is enabled0 = Eye-Pattern Test is disabled

bit 6 **UOEMON:** USB OE Monitor Enable bit

1 = OE signal is active; it indicates intervals during which the D+/D- lines are driving

0 = OE signal is inactive

bit 5 Unimplemented: Read as '0'

bit 4 USBSIDL: Stop in Idle Mode bit

1 = Discontinue module operation when the device enters Idle mode

0 = Continue module operation when the device enters Idle mode

bit 3-1 Unimplemented: Read as '0'

bit 0 **UASUSPND:** Automatic Suspend Enable bit

- 1 = USB module automatically suspends upon entry to Sleep mode. See the USUSPEND bit (U1PWRC<1>) in Register 10-5.
- 0 = USB module does not automatically suspend upon entry to Sleep mode. Software must use the USUSPEND bit (U1PWRC<1>) to suspend the module, including the USB 48 MHz clock.

TXCON: TYPE B TIMER CONTROL REGISTER REGISTER 13-1:

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	-	-	_	-	_	_
22:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	-	_	_
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ^(1,3)	_	SIDL ⁽⁴⁾	_	_	_	_	_
7:0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	U-0
7:0	TGATE ⁽³⁾	Т	CKPS<2:0>(3	3)	T32 ⁽²⁾	_	TCS ⁽³⁾	_

Legend:

W = Writable bit R = Readable bit U = Unimplemented bit, read as '0'

'1' = Bit is set n = Value at POR '0' = Bit is cleared x = Bit is unknown

bit 31-16 **Unimplemented:** Read as '0'

bit 15 ON: Timer On bit(1,3)

> 1 = Module is enabled 0 = Module is disabled

bit 14 Unimplemented: Read as '0' bit 13

SIDL: Stop in Idle Mode bit⁽⁴⁾

1 = Discontinue module operation when the device enters Idle mode 0 = Continue module operation when the device enters Idle mode

bit 12-8 Unimplemented: Read as '0'

bit 7 **TGATE:** Timer Gated Time Accumulation Enable bit⁽³⁾

When TCS = 1:

This bit is ignored and is read as '0'.

When TCS = 0:

1 = Gated time accumulation is enabled 0 = Gated time accumulation is disabled

TCKPS<2:0>: Timer Input Clock Prescale Select bits(3) bit 6-4

111 = 1:256 prescale value

110 = 1:64 prescale value

101 = 1:32 prescale value

100 = 1:16 prescale value

011 = 1:8 prescale value

010 = 1:4 prescale value

001 = 1:2 prescale value

000 = 1:1 prescale value

- Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.
 - 2: This bit is available only on even numbered timers (Timer2 and Timer4).
 - 3: While operating in 32-bit mode, this bit has no effect for odd numbered timers (Timer3, and Timer5). All timer functions are set through the even numbered timers.
 - While operating in 32-bit mode, this bit must be cleared on odd numbered timers to enable the 32-bit timer in Idle mode.

REGISTER 16-1: OCxCON: OUTPUT COMPARE 'x' CONTROL REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_	_	_	_	_	_	_
22.46	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	_	_	_	_	_	_	_	_
45.0	R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ⁽¹⁾	_	SIDL	_	_	_	_	_
7.0	U-0	U-0	R/W-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	_	OC32	OCFLT ⁽²⁾	OCTSEL		OCM<2:0>	

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

bit 15 **ON:** Output Compare Peripheral On bit⁽¹⁾

1 = Output Compare peripheral is enabled

0 = Output Compare peripheral is disabled

bit 14 Unimplemented: Read as '0'

bit 13 SIDL: Stop in Idle Mode bit

1 = Discontinue module operation when the device enters Idle mode

0 = Continue module operation when the device enters Idle mode

bit 12-6 Unimplemented: Read as '0'

bit 5 OC32: 32-bit Compare Mode bit

1 = OCxR<31:0> and/or OCxRS<31:0> are used for comparisons to the 32-bit timer source

0 = OCxR<15:0> and OCxRS<15:0> are used for comparisons to the 16-bit timer source

bit 4 OCFLT: PWM Fault Condition Status bit⁽²⁾

1 = PWM Fault condition has occurred (cleared in hardware only)

0 = No PWM Fault condition has occurred

bit 3 OCTSEL: Output Compare Timer Select bit

1 = Timer3 is the clock source for this Output Compare module

0 = Timer2 is the clock source for this Output Compare module

bit 2-0 OCM<2:0>: Output Compare Mode Select bits

111 = PWM mode on OCx; Fault pin enabled

110 = PWM mode on OCx; Fault pin disabled

101 = Initialize OCx pin low; generate continuous output pulses on OCx pin

100 = Initialize OCx pin low; generate single output pulse on OCx pin

011 = Compare event toggles OCx pin

010 = Initialize OCx pin high; compare event forces OCx pin low

001 = Initialize OCx pin low; compare event forces OCx pin high

000 = Output compare peripheral is disabled but continues to draw current

Note 1: When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

2: This bit is only used when OCM<2:0> = '111'. It is read as '0' in all other modes.

19.1 UART Control Registers

TABLE 19-1: UART1 AND UART2 REGISTER MAP

ess										Bi	ts								,,
Virtual Address (BF80_#)	Register Name	Bit Range	31/15	30/14	29/13	28/12	27/11	26/10	25/9	24/8	23/7	22/6	21/5	20/4	19/3	18/2	17/1	16/0	All Resets
6000	U1MODE ⁽¹⁾	31:16	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	_	0000
0000	OTWODE	15:0	ON	_	SIDL	IREN	RTSMD	_	UEN:	<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSE	L<1:0>	STSEL	0000
6010	U1STA ⁽¹⁾	31:16	_	_	_	_	_	_	_	ADM_EN				ADDR					0000
0010	O IOIA.	15:0	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXIS	EL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
6020	U1TXREG	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
0020	UTTAINEG	15:0	_	_	_	_	_	_	-				Tra	nsmit Regis	ster				0000
6030	U1RXREG	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
0000	U1RXREG 1	15:0	_	_	_	_	_	_	-				Re	ceive Regis	ster				0000
6040	U1BRG ⁽¹⁾	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
00+0	O IDICO.	15:0							Bau	d Rate Gene	erator Pres	caler							0000
6200	U2MODE ⁽¹⁾	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
0200	02MODE: 1	15:0	ON	_	SIDL	IREN	RTSMD	_	UEN:	<1:0>	WAKE	LPBACK	ABAUD	RXINV	BRGH	PDSE	L<1:0>	STSEL	0000
6210	U2STA ⁽¹⁾	31:16	_	_	_	_	_	_	-	ADM_EN				ADDR	R<7:0>				0000
0210	02017	15:0	UTXISE	L<1:0>	UTXINV	URXEN	UTXBRK	UTXEN	UTXBF	TRMT	URXISE	EL<1:0>	ADDEN	RIDLE	PERR	FERR	OERR	URXDA	0110
6220	U2TXREG	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
0220	OZIANLO	15:0	_	_	_	_	_	_	_				Tra	nsmit Regis	ster				0000
6230	U2RXREG	31:16	_	_	_	_	_	_	-	_	_	_	_	-	_	_	_	_	0000
0230	UZIVANLU	15:0	_	_	_	_	_	_	-				Re	ceive Regis	ster				0000
6240	U2BRG ⁽¹⁾	31:16	_	-	_	-	_	_	I	_	_	_	-	-	_	_	_	_	0000
0240	OZDNO,	15:0 Baud Rate Generator Prescaler								0000									

Legend: x = unknown value on Reset; — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: This register has corresponding CLR, SET and INV registers at its virtual address, plus an offset of 0x4, 0x8 and 0xC, respectively. See Section 11.2 "CLR, SET and INV Registers" for more information.

26.4 Peripheral Module Disable

The Peripheral Module Disable (PMD) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled using the appropriate PMD control bit, the peripheral is in a minimum power consumption state. The control and status registers associated with the peripheral are also disabled, so writes to those registers do not have effect and read values are invalid.

To disable a peripheral, the associated PMDx bit must be set to '1'. To enable a peripheral, the associated PMDx bit must be cleared (default). See Table 26-1 for more information.

Note: Disabling a peripheral module while it's ON bit is set, may result in undefined behavior. The ON bit for the associated peripheral module must be cleared prior to disable a module via the PMDx bits.

TABLE 26-1: PERIPHERAL MODULE DISABLE BITS AND LOCATIONS

Peripheral ⁽¹⁾	PMDx bit Name ⁽¹⁾	Register Name and Bit Location
ADC1	AD1MD	PMD1<0>
СТМИ	CTMUMD	PMD1<8>
Comparator Voltage Reference	CVRMD	PMD1<12>
Comparator 1	CMP1MD	PMD2<0>
Comparator 2	CMP2MD	PMD2<1>
Comparator 3	CMP3MD	PMD2<2>
Input Capture 1	IC1MD	PMD3<0>
Input Capture 2	IC2MD	PMD3<1>
Input Capture 3	IC3MD	PMD3<2>
Input Capture 4	IC4MD	PMD3<3>
Input Capture 5	IC5MD	PMD3<4>
Output Compare 1	OC1MD	PMD3<16>
Output Compare 2	OC2MD	PMD3<17>
Output Compare 3	OC3MD	PMD3<18>
Output Compare 4	OC4MD	PMD3<19>
Output Compare 5	OC5MD	PMD3<20>
Timer1	T1MD	PMD4<0>
Timer2	T2MD	PMD4<1>
Timer3	T3MD	PMD4<2>
Timer4	T4MD	PMD4<3>
Timer5	T5MD	PMD4<4>
UART1	U1MD	PMD5<0>
UART2	U2MD	PMD5<1>
SPI1	SPI1MD	PMD5<8>
SPI2	SPI2MD	PMD5<9>
I2C1	I2C1MD	PMD5<16>
I2C2	I2C2MD	PMD5<17>
USB ⁽²⁾	USBMD	PMD5<24>
RTCC	RTCCMD	PMD6<0>
Reference Clock Output	REFOMD	PMD6<1>
PMP	PMPMD	PMD6<16>

Note 1: Not all modules and associated PMDx bits are available on all devices. See TABLE 1: "PIC32MX1XX 28/36/44-Pin General Purpose Family Features" and TABLE 2: "PIC32MX2XX 28/36/44-pin USB Family Features" for the lists of available peripherals.

^{2:} The module must not be busy after clearing the associated ON bit and prior to setting the USBMD bit.

27.0 SPECIAL FEATURES

Note:

This data sheet summarizes the features of the PIC32MX1XX/2XX 28/36/44-pin Family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to "Configuration" Section 32. Section (DS60001124) and "Programming and Diagnostics" (DS60001129), which are available from the Documentation > Reference Manual section of the Microchip PIC32 web site (www.microchip.com/pic32).

PIC32MX1XX/2XX 28/36/44-pin Family devices include the following features intended to maximize application flexibility, reliability and minimize cost through elimination of external components.

- · Flexible device configuration
- Joint Test Action Group (JTAG) interface
- In-Circuit Serial Programming™ (ICSP™)

27.1 Configuration Bits

The Configuration bits can be programmed using the following registers to select various device configurations.

- DEVCFG0: Device Configuration Word 0
- DEVCFG1: Device Configuration Word 1
- DEVCFG2: Device Configuration Word 2
- DEVCFG3: Device Configuration Word 3
- · CFGCON: Configuration Control Register

In addition, the DEVID register (Register 27-6) provides device and revision information.

TABLE 30-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +105^{\circ}\text{C}$ for V-temp				
Param. No.	Typical ⁽²⁾	Max.	Units	Conditions			
Power-Down Current (IPD) (Notes 1, 5)							
DC40k	44	70	μА	-40°C			
DC40I	44	70	μА	+25°C	Base Power-Down Current		
DC40n	168	259	μΑ	+85°C	- base rower-bown current		
DC40m	335	536	μA	+105°C			
Module Differential Current							
DC41e	5	20	μΑ	3.6V	Watchdog Timer Current: ΔIWDT (Note 3)		
DC42e	23	50	μΑ	3.6V	RTCC + Timer1 w/32 kHz Crystal: ΔIRTCC (Note 3)		
DC43d	1000	1100	μА	3.6V	ADC: ΔIADC (Notes 3,4)		

Note 1: The test conditions for IPD current measurements are as follows:

- Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)
- OSC2/CLKO is configured as an I/O input pin
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Sleep mode, and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
- · WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- · RTCC and JTAG are disabled
- **2:** Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 3: The Δ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.
- 5: IPD electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

TABLE 30-14: COMPARATOR VOLTAGE REFERENCE SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +105^{\circ}\text{C}$ for V-temp						
Param. No.	Symbol	Characteristics	Min.	Тур.	Max.	Units	Comments		
D312	TSET	Internal 4-bit DAC Comparator Reference Settling time	_	_	10	μs	See Note 1		
D313	D313 DACREFH		AVss	_	AVDD	V	CVRSRC with CVRSS = 0		
		Reference Range	VREF-	_	VREF+	V	CVRSRC with CVRSS = 1		
1		CVREF Programmable Output Range	0	-	0.625 x DACREFH	V	0 to 0.625 DACREFH with DACREFH/24 step size		
			0.25 x DACREFH	_	0.719 x DACREFH	V	0.25 x DACREFH to 0.719 DACREFH with DACREFH/32 step size		
D315	DACRES	Resolution	_	_	DACREFH/24	_	CVRCON <cvrr> = 1</cvrr>		
			_	_	DACREFH/32	_	CVRCON <cvrr> = 0</cvrr>		
D316	DACACC	Absolute Accuracy ⁽²⁾	_	_	1/4	LSB	DACREFH/24, CVRCON <cvrr> = 1</cvrr>		
			_	_	1/2	LSB	DACREFH/32, CVRCON <cvrr> = 0</cvrr>		

Note 1: Settling time was measured while CVRR = 1 and CVR<3:0> transitions from '0000' to '1111'. This parameter is characterized, but is not tested in manufacturing.

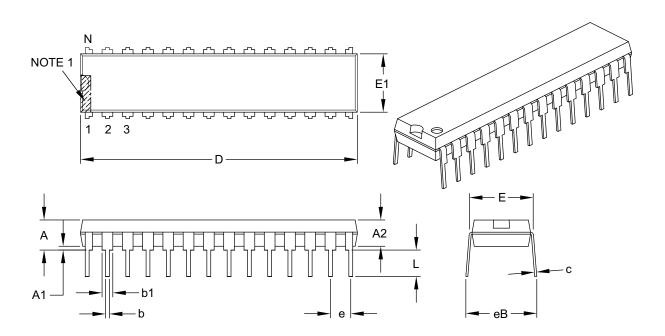
TABLE 30-15: INTERNAL VOLTAGE REGULATOR SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \le \text{TA} \le +105^{\circ}\text{C}$ for V-temp				
Param. No.	Symbol	Characteristics	Min.	Typical	Max.	Units	Comments
D321	CEFC	External Filter Capacitor Value	8	10		μF	Capacitor must be low series resistance (1 ohm). Typical voltage on the VCAP pin is 1.8V.

^{2:} These parameters are characterized but not tested.

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	INCHES					
	MIN	NOM	MAX			
Number of Pins	N	28				
Pitch	е	.100 BSC				
Top to Seating Plane	A	-	_	.200		
Molded Package Thickness	A2	.120	.135	.150		
Base to Seating Plane	A1	.015	_	-		
Shoulder to Shoulder Width	E	.290	.310	.335		
Molded Package Width	E1	.240	.285	.295		
Overall Length	D	1.345	1.365	1.400		
Tip to Seating Plane	L	.110	.130	.150		
Lead Thickness	С	.008	.010	.015		
Upper Lead Width	b1	.040	.050	.070		
Lower Lead Width		.014	.018	.022		
Overall Row Spacing §	еВ	-	_	.430		

Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. § Significant Characteristic.
- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B

Revision D (February 2012)

All occurrences of VUSB were changed to: VUSB3V3. In addition, text and formatting changes were incorporated throughout the document.

All other major changes are referenced by their respective section in Table A-3.

TABLE A-3: MAJOR SECTION UPDATES

Section	Update Description				
"32-bit Microcontrollers (up to 128	Corrected a part number error in all pin diagrams.				
KB Flash and 32 KB SRAM) with Audio and Graphics Interfaces, USB, and Advanced Analog"	Updated the DMA Channels (Programmable/Dedicated) column in the PIC32MX1XX General Purpose Family Features (see Table 1).				
1.0 "Device Overview"	Added the TQFP and VTLA packages to the 44-pin column heading and updated the pin numbers for the SCL1, SCL2, SDA1, and SDA2 pins in the Pinout I/O Descriptions (see Table 1-1).				
7.0 "Interrupt Controller"	Updated the Note that follows the features.				
	Updated the Interrupt Controller Block Diagram (see Figure 7-1).				
29.0 "Electrical Characteristics"	Updated the Maximum values for parameters DC20-DC24, and the Minimum value for parameter DC21 in the Operating Current (IDD) DC Characteristics (see Table 29-5).				
	Updated all Minimum and Maximum values for the Idle Current (IIDLE) DC Characteristics (see Table 29-6).				
	Updated the Maximum values for parameters DC40k, DC40l, DC40n, and DC40m in the Power-down Current (IPD) DC Characteristics (see Table 29-7).				
	Changed the minimum clock period for SCKx from 40 ns to 50 ns in Note 3 of the SPIx Master and Slave Mode Timing Requirements (see Table 29-26 through Table 29-29).				
30.0 "DC and AC Device Characteristics Graphs"	Updated the Typical IIDLE Current @ VDD = 3.3V graph (see Figure 30-5).				

NOTES: